

RJ45C5 R12U 1.7N4G/Y RL**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

The product range encompasses the following designs:

- 90°, lying (horizontal) and 180°, standing (vertical)
- latch up / latch down
- THT, THR or SMD soldering processes
- Wide range of different design types, also with integrated LEDs and shield contact tabs
- Performance category Cat. 3 to Cat. 6
- Packed either in a tray (TY) or on a roll (tape-on-reel, RL)
- Compatible with modular RJ45 connector according to ANSI / TIA-1096-A and IEC 60603
- Dielectric strength ≥ 1500 V AC RMS (2250 V AC peak value) according to IEEE 802.3
- Dielectric strength ≥ 1500 V AC (peak value) or ≥ 1500 V DC according to IEC 60603

Properties and advantages:

- Extended temperature range of -40°C to $+85^{\circ}\text{C}$ for maximum performance
- Reinforced gold layer (30 μm) for improved corrosion protection
- At least 0.3mm stand-off ensures a perfect soldering result

General ordering data

Version	PCB plug-in connector, RJ45 jacks, Cat. 5 , THT/THR solder connection, 90°, Latch option: bottom, Shield tabs: none, LED: Yes, green, yellow, Number of poles: 16, Tape
Order No.	2661430000
Type	RJ45C5 R12U 1.7N4G/Y RL
GTIN (EAN)	4050118674651
Qty.	240 pc(s).
Packaging	Tape

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Technical data

Dimensions and weights

Depth	15.7 mm	Depth (inches)	0.618 inch
Height	13.1 mm	Height (inches)	0.516 inch
Height of lowest version	13.1 mm	Width	32.2 mm
Width (inches)	1.268 inch	Net weight	5.958 g

System specifications

Category	Cat. 5	Colour of left LED	green
Colour of right LED	yellow	Forward current	20 mA
Forward voltage, max.	2.6 V	Forward voltage, min.	1.8 V
LED	Yes	Latch option	bottom
Mounting onto the PCB	THT/THR solder connection	Number of poles	16
Outgoing elbow	90°	Performance-Category	Cat. 5
Pitch in inches (P)	0.04 "	Pitch in mm (P)	1.02 mm
Plugging cycles	750	Product family	OMNIMATE Data - RJ45 modular jack
Protection degree	IP20	Shield surface	nickel-plated
Shield tabs	none	Shielding	Yes
Solder pin dimensions	Octagonal	Solder pin length (l)	1.7 mm
Soldering process	Reflow soldering, Manual soldering, Wave soldering	Tolerance of solder pin position	± 0.20 mm
Type of connection	Solder connection		

Electrical properties

Dielectric strength, contact / contact	1000 V DC	Dielectric strength, contact / shield	1500 V DC
Insulation strength	≥ 500 MΩ	PoE / PoE+	conforming to IEEE 802.3at
Rated current	1.5 A	Rated voltage	125 V

Material data

Insulating material	PA 9T	Colour	black
Colour chart (similar)	RAL 9011	Insulation strength	≥ 500 MΩ
Moisture Level (MSL)	1	UL 94 flammability rating	V-0
Contact material	Cu-alloy	Contact surface	Gold over nickel
Operating temperature, min.	-40 °C	Operating temperature, max.	85 °C

Packing

Packaging	Tape	VPE length	330 mm
VPE width	330 mm	VPE height	61 mm

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ETIM 9.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01
ECLASS 12.0	27-46-02-01	ECLASS 13.0	27-46-02-01

Approvals

ROHS	Conform
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Creation date June 15, 2024 5:39:47 AM CEST

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Technical data

Downloads

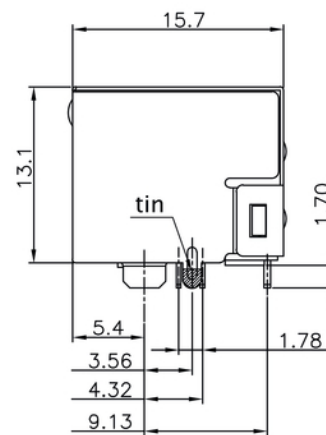
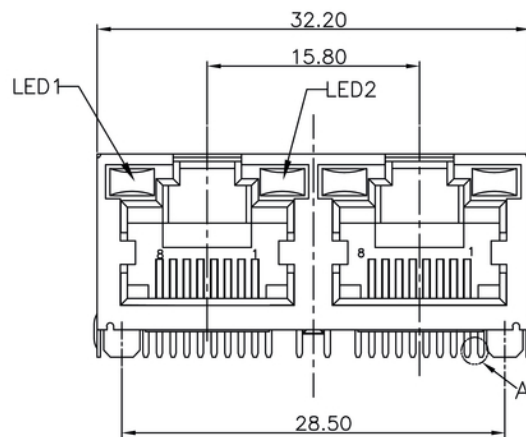
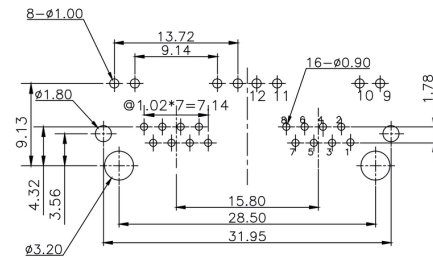
Approval/Certificate/Document of Conformity	Certificate of Compliance
Engineering Data	CAD data – STEP
Catalogues	Catalogues in PDF-format

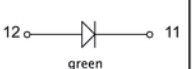
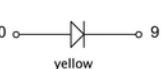
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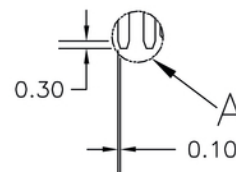
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Drawings



LED1	LED2
	



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RJ45	G1	R1	U1	U2	E4	GY/GY	TY	RJ45G R1U 3.2E4GY/GY TY	
							Packaging	TY RL	Ty in box (manual assembly) Tape on Reel (automated assembly)
							LED	Y/G G/Y GY/GY O/G R/O ... N	Yellow/Green Green/Yellow (standard) Green-Yellow/Green-Yellow Orange-Green Red/Orange ... (further combinations possible) without LED
							Contact surface thickness	4	1 = 3µ", 2 = 6µ", 3 = 15µ", 4 = 30µ", 5 = 50µ"
							EMI tabs (ground fingers)	N	E = with EMI tabs N = without EMI tabs
							Solder Pin length	3.2 1.6 D	3.2 mm 1.6 mm SMD
							Direction, latch style	U D V Y	Horizontal (90°, side entry), latch up Horizontal (90°, side entry), latch down Vertical (180°, top entry) Diagonal (45°), latch up
							Number of Ports	1 12; 14; ... 21; 41; ...	1 Port multi ports side by side, Multiport multi ports about each other, Multilevel
							Assembly on PCB	R S T	Through Hole Reflow - THR Soldering process: Wave or Reflow soldering Surface Mount Technology - SMT Soldering process: Reflow soldering Through Hole Technology - THT Soldering process: Wave
							Performance Category	C5 C6 C6A C5e M G1 G10 U MP MP+	Category 5 Category 6 Category 6A Category 5e 10/100 Mbit 10/100/1000 Mbit 10 Gbit Unshielded 10/100 Mbit with PCE 10/100 Mbit with PCE+

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Recommended wave soldering profiles

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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.